

# Optimized Power Management for Air-Cooled Data Centers

A telemetry-driven framework for improving energy productivity

A supplementary framework for evaluating total energy consumed per completed workload in air-cooled environments.

**OPM™ overview version**

May 2026

## What it is: a closed-loop energy productivity layer

- OPM™ is a telemetry-driven control system designed to minimize total energy consumed per unit of useful work.
- It is built for air-cooled data centers where compute, storage and cooling behavior interact.
- The framework applies to compute-intensive and I/O-intensive workloads, including AI training, HPC, simulations, rendering, databases, analytics and transactional systems.
- It supplements PUE and existing thermal guidance rather than replacing them.

**OPM™ optimizes computational energy productivity, not facility overhead alone.**

**Lower**

energy per workload

**Faster**

workload completion

**Higher**

asset utilization

## What it does (and does not do)

### What it does

- Optimize total energy per workload
- Reduce thermal throttling
- Reduce fan-power spikes
- Reduce vibration-related storage penalties
- Improve job completion time

### What it does not do

- Change power distribution infrastructure
- Replace cooling infrastructure
- Assume higher setpoints are always better
- Aim to improve PUE directly

**PUE measures facility overhead. OPM™ optimizes computational energy productivity.**

# Why facility-only metrics can miss workload energy

## What PUE captures

- PUE is useful for measuring facility overhead.
- It compares total facility energy to IT energy.
- It does not measure useful work completed.

## What can be hidden

- A lower PUE can coincide with higher energy per workload if runtime rises.
- Thermal stress can trigger leakage, throttling, fan power and storage latency.
- Energy and throughput must be reported together to judge productivity.

**The operating target is minimum energy per completed workload - not minimum PUE alone.**

## Key mechanisms that increase energy per workload

### Chip leakage

Leakage power rises with temperature, increasing consumed energy.

### DVFS / throttling

Throughput can drop near thermal limits; jobs run longer.

### Fan power

Fan power changes nonlinearly with RPM, creating spikes.

### Storage effects

HDD latency and I/O retry penalties can rise under vibration.

## Telemetry sources used by OPM™

### Electrical

On-board voltage and current sensors

### Thermal / control

CPU/GPU thermal sensors and DVFS state data

### Mechanical / I/O

Fan RPM, vibration signatures and storage I/O counters

**These effects can increase total energy per job even when instantaneous IT power appears lower.**

# Conceptual comparison of operating modes

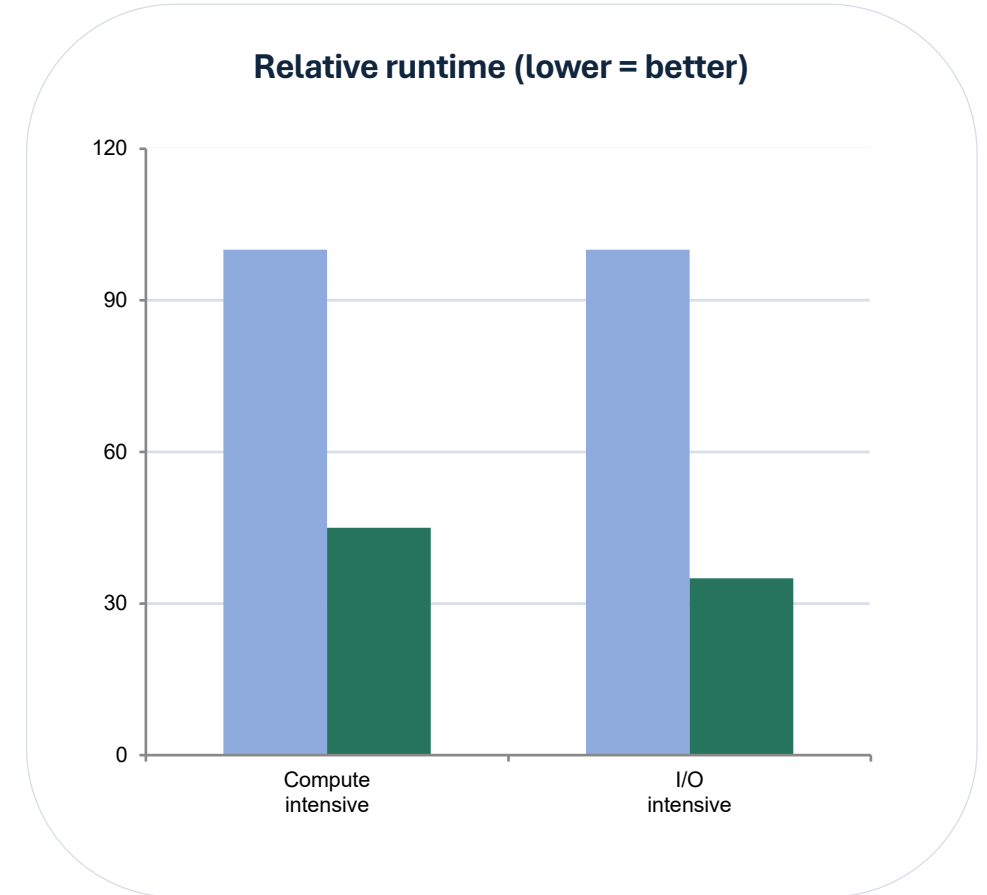
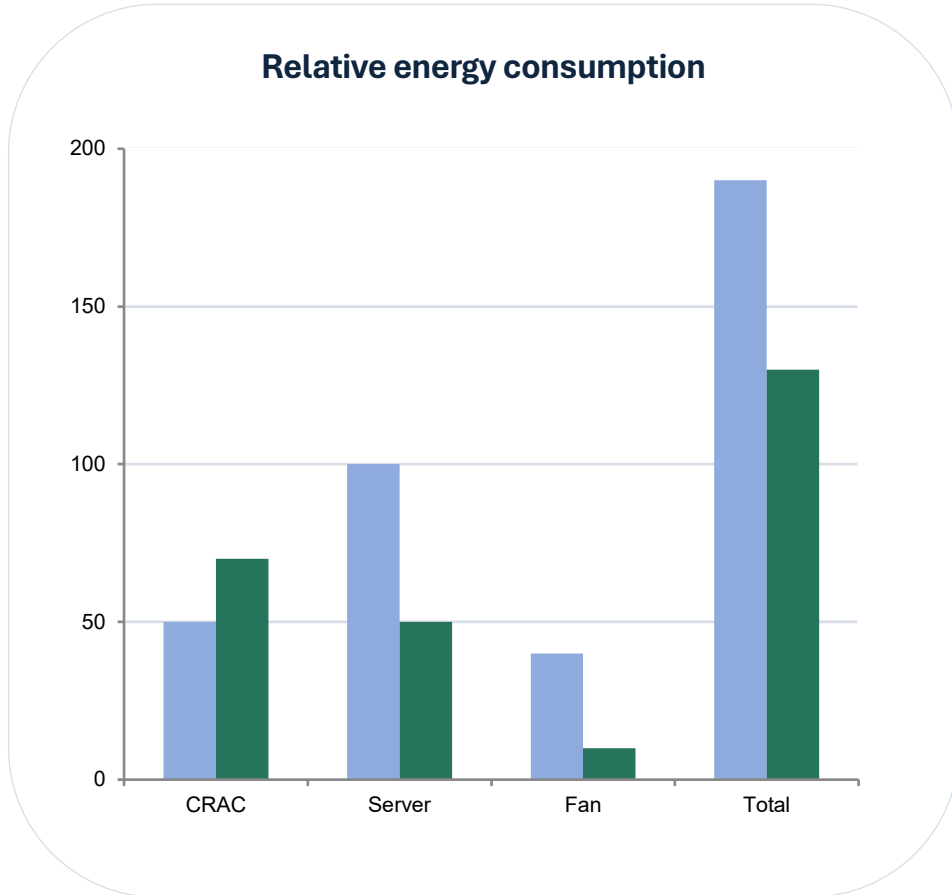
Illustrative comparison; site-specific results should be established by pilot measurement.

Static thermal setpoint

Telemetry optimized

**Compare**

- Runtime
- Fan power
- Throttling
- Storage latency
- Total energy per workload



## Where it delivers the most impact

### Compute-intensive

AI training, HPC, simulations and rendering workloads where runtime and throttling matter.

### I/O-intensive

Databases, analytics and transactional systems where storage latency affects job energy.

### Air-cooled sites

Facilities using CRAC/CRAH systems, including HDD-heavy environments.

**OPM™ is most useful where IT behavior, cooling setpoints and workload scheduling interact.**

# Expected outcomes under suitable conditions

When properly implemented in air-cooled environments with mixed compute and storage loads, OPM™ can deliver:

## Reduced

total electricity  
consumption

## Faster

workload completion

## Higher

asset utilization

## Lower

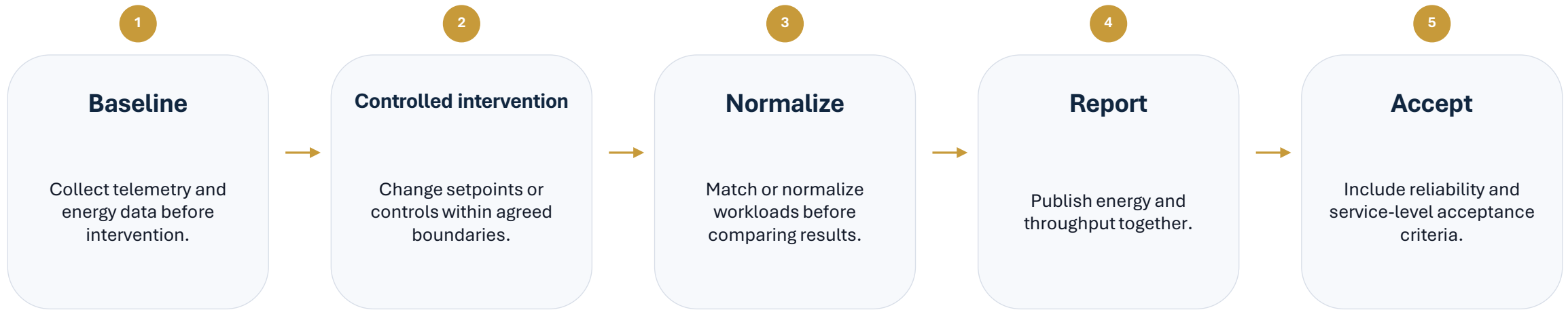
emissions per unit of work

**Savings come from avoiding throttling, reducing fan spikes, limiting leakage escalation, shortening runtime and improving setpoint selection.**

## Operating benefits

- Deferred infrastructure expansion
- Lower carbon emissions per unit of useful work
- Better reporting of energy and throughput together

# Recommended pilot validation framework



- Pilot measurement should establish site-specific performance before operational adoption.
- The goal is not a generic savings claim; the goal is a measured energy-productivity result.

## Selected technical basis

- 1 Leakage-aware control** Workload/cooling management accounts for temperature-driven leakage power.
- 2 Fan-speed-aware scheduling** Scheduling and setpoints consider nonlinear fan energy.
- 3 DVFS interaction** Control choices account for performance and energy tradeoffs.
- 4 Storage degradation** Thermo-mechanical effects can influence HDD latency and I/O rates.
- 5 Cold aisle optimization** Setpoints are optimized against workload energy, not PUE alone.

**The common thread: control decisions must include IT energy, workload runtime and cooling behavior together.**

## Core principle

**Cooling setpoints should be optimized for minimum energy per workload, not minimum PUE alone.**

- PUE remains useful for facility overhead.
- OPM™ adds a workload-centered lens: energy consumed per useful work completed.
- The pilot objective is to prove that the combined metric improves operating decisions.

**Measure energy and throughput together before declaring a setpoint optimal.**

## Bibliography: energy productivity mechanisms

External scientific publications documenting the physics behind the three parasitic energy-wastage mechanisms: CPU/GPU leakage power, fan motor power and system ambient vibrations.

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